

B RHS

CRYSTAL SPECIFICATION

Customer	:		
Customer P/N	:		
Agent	:		
Agent Code	:		
SIWARD P/N	:	XTL721-S999-311	

Customer Approval :

希華晶體科技股份有限公司 SIWARD CRYSTAL TECHNOLOGY CO., LTD.

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2017/06/14 DATE ·

Approved By

Checked By

Designer

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Rev.	Description of Revision History	Date	Designer	Checked B
1	New Publication	2012/08/08	Sally Lin	Steve Cher
2	Dimension: SX-3215 become to SF-3215.(101K1209-017)	2012/09/24	Sally Lin	Steve Cher
3	Freq. vs Temp. Coefficient Before Changed : - 0.025 MIN; - 0.035 TYP ; - 0.045 MAX .(K1312-017)	2014/01/02	Sally Lin	Tom Tang
4	C0 Before Changed : 2 pF Max ; C1 Before Changed:3 fF MIN. (K1601-006)	2016/01/15	Sally Lin	Tom Tang



CRYSTAL SPECIFICATION

1.	Description	:	Quartz Crystal
2.	Nominal Frequency	:	32.768 KHz
3.	Center Frequency	:	32.768 KHz
4.	Dimension & Drawing No.	:	SF-3215 ; SXD-00281
5.	Oscillation Mode	:	Fundamental
6.	Cutting Mode	:	
7.	Packing Style	:	TP-175
8.	Measurement Instrument	:	S&A 250B(Calculated FL)

:

9. Electrical Characteristics [1] Operating Conditions :

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Operating Temperature Range	Topt	-40		85	°C	
Storage Temperature Range	Tstg	-55		125	°C	
Load Capacitance	CL		12.5		pF	
Drive Level	DL		0.1	0.5	μW	

[2] Frequency Stability :

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Tolerance	dF/Fo	-20		20	ppm	Refer to Center Frequency @25 \pm 3°C DL = 0.1 μ W
Freq. vs Temp. Coefficient	dF/dT	-0.02	-0.03	-0.04	ppm/°C ^2	Values are calculated by frequencies at 10 $^\circ\!C$, 25 $^\circ\!C$, and 40 $^\circ\!C$
Turnover Temperature	TT	20	25	30	°C	
Aging	dF/F25	-3		3	ppm	Per Year

dF/Fo: Frequency Deviation Refer to Center Frequency

dF/F25: Frequency Deviation Refer to 25 $^\circ\!\mathrm{C}\,$ Frequency



[3] Electrical Performance :

Item	Symbol	MIN.	TYP.	MAX.	Unit	Condition
Equivalent Series Resistance	ESR			70000	Ω	@Series
Shunt Capacitance	C0		1.1		pF	
Motional Capacitance	C1		4.7		fF	
Quality Factor	Q	13			K	
Insulation Resistance	IR	500			MΩ	@DC 100 Volt

10. Marking : Laser

*MARKING : D ->	>YEAR C-> MONTH
YEAR : 1 2 3	4 5 6 7 8 9 0
CODE : A B C	DEFGHJK
MONTH: 1 2 3	4 5 6 7 8 9 10 11 12
CODE : A B C	DEFGHJKLM
* S -> SIWARD	* ### -> Lot No

SDC###

11. Remark :

* The component complies with Moisture Sensitivity Level 1 defined on JEDEC J-STD-020 standard. *Compliant with RoHS and Siward QAD-S-116 Standard.

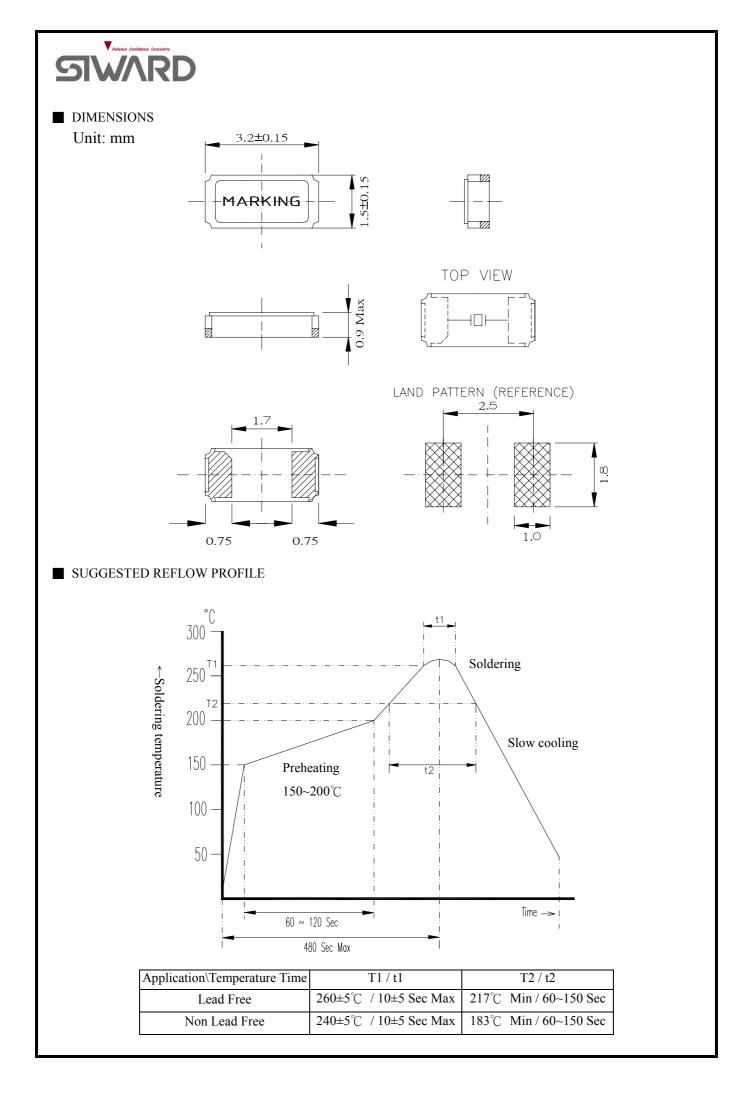
■Note

1. Tuning fork products oscillate at frequency bands that are close to the washing frequency of ultrasonic cleaning machine, which may cause resonance deteriorating the electrical characteristics in devices, and even damaging the overall structure of devices. Therefore, using ultrasonic cleaning machine to clean tuning fork devices should be avoided. If the use of this method to clean tuning fork devices is required, it's suggested to check the functionality of devices before and after the cleaning process.

2. Avoid mounting and processing by Ultrasonic welding this method has a possibility of an excessive vibration spreading inside the crystal products and becoming the cause of characteristic deterioration and not oscillating.

3.Manual soldering heat resistance

Pressing a soldering iron of 400°C on the terminal electrode for four seconds (twice).





RELIABILITY SPECIFICATION

REFER TO JIS C 6701

1. ENVIRONMENTAL PERFORMANCE

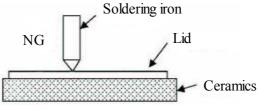
ITEM	CONDITION
1. HIGH TEMPERATURE	STORED AT 85±2°C FOR 500±12H. (If Customer's temperature request
STORAGE	is higher than the standard, Temperature test must be done for customer
	requirements.) THEN $25\pm2^{\circ}$ OVER 2H BEFORE TESTING.
2. LOW TEMPERATURE	STORED AT $-40\pm2^{\circ}$ C FOR 500 ±12 H. (If Customer's temperature request
STORAGE	is lower than the standard, Temperature test must be done for customer
	requirements.) THEN $25\pm2^{\circ}$ OVER 2H BEFORE TESTING.
3. HIGH TEMP. & HUMIDITY	STORED AT $60\pm2^{\circ}$ C AND HUMIDITY $90\sim95\%$ FOR 500 ± 12 H.
	THEN $25\pm 2^{\circ}$ C OVER 2H BEFORE TESTING.
4. TEMPERATURE CYCLE	THE CRYSTAL UNIT SHALL BE SUBJECTED TO 100 SUCCESSIVE
	CHANGE OF TEMPERATURE CYCLES, THEN $25\pm2^{\circ}$ C OVER 2 H
	BEFORE TESTING, EACH CYCLE AS BELLOW:
	TEMPERATURE DURATION
	140+0/-6°C 30±3 MINUTES
	2. $25^{\circ}C\pm 2^{\circ}C$ 2~3 MINUTES
	3. 85+4/-0°C 30 ±3 MINUTES
	4. 25° C $\pm 2^{\circ}$ C $2 \sim 3$ MINUTES

2. MECHANICAL PERFORMANCE

ITEM	CONDITION
5. RESISTANCE TO	REFLOW CHART AS ATTACH SHEET. TWICE PASS.
SOLDERING HEAT	
6. DROP	Dumy: 150 g,
	Height : 180 cm,
	Dropped Cycle : 3 Cycle,
	DROP IT ONTO A CONCRETE BOARD FOR 6 DIRECTIONS
	(XX',YY'ZZ'). THIS SHOULD BE 1 CYCLE.
7. VIBRATION	FREQUENCY : 10~60Hz,
	AMPLITUDE (TOTAL EXCURSION) : 1.5mm±15%,
	SWEEP TIME(PERIOD) : 2~3 min, 3 DIRECTION (X, Y, Z) EACH FOR 2 Hrs.
8. FINE LEAK	HELIUM BOMBING 5.0~5.5 Kgf/cm ²
	FOR 2 HOURS.

(Remark)

Please note that parts should specify above test condition each by each article not all at once. Also the variation of series resistance should $\pm 20\%$ min or $\pm 15k\Omega$ min which ever big value on above test. Please do not touch by hot soldering iron and do not put shock on top lid.



9. TERMINAL STRENGTH	SHALL BE PRESSURIZED AT A SPEED OF APPROX.0.5mm/sec IN
	THE DIRECTION INDICATED BY THE ARROW UNTIL THE
	BENDING WIDTH REACHES 3mm AND HELD FOR 5 SECONDS.
	PRESSURE ROD R20
	R5 A SAMPLE A R5
	45±2 45±2
10. STICKING TENDENCY	A R0.5 JIG SHALL BE USED TO APPLY A 10N DEAD LOAD IN THE
	DIRECTION INDICATED BY THE ARROW TO THE ELEMENT AND
	THE DO S
	TC DO 5
11. ELEMENT ASSEMBLY	RETAIN IT FOR 10 SECONDS.
11. ELEMENT ASSEMBLY STRENGTH	RETAIN IT FOR 10 SECONDS.

